Approved for use through 10/31/2002. OMB 0651-0031
U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

Substitute for form 1449A/PTO

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet 2 of 2

Complete if Known	
Application Number	10/659585
Filing Date	September 10, 2003
First Named Inventor	Shunpei YAMAZAKI et al.
Group Art Unit	2813
Examiner Name	Heather Doty
Attorney Docket Number	0756-7196

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No.[1]	U.S. Patent Document Number	Kind Code[2] (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
HD		6,015,724		Yamazaki	01/18/2000	
HD		4,033,833		Bestel et al.	07/05/1977	
HD		5,726,461		Shimada et al.	03/10/1998	
HD		6,359,320		Yamazaki et al.	03/19/2002	
HD		5,851,918		Song et al.	12/22/1998	
HD		5,929,948		Ohori et al.	07/27/1999	
HD		6,509,616		Yamazaki	01/21/2003	
HD		2001/0010370		Kimura et al.	08/02/2001	
HD		6,413,845		Izumi et al.	07/02/2002	
HD		6,515,365		Higashi et al.	02/05/2003	
HD		6,573,602		Seo et al.	06/03/2003	
HD		6,509,649		Sugai	01/21/2003	
HD		6,479,900		Shinogi	~~12/12/2000~~ 11/2002	

KLEM 7/11/06

FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No.[1]	Foreign Patent Document Office[3]	Number[4]	Kind Code[5] (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T[6]

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No.[1]	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T[2]
HD		Stanley Wolf "4.5.6.3 Contact-Hole and Via Filling with Selective Electroless Metal Deposition," Silicon Processing for the VLSI Era, Vol. 2, Process Integration, pp. 256-257	
HD		M. Hatano et al., "A Novel Self-Aligned Gate-Overlapped LDD Poly-Si TFT with High Reliability and Performance," IEDM 97, pp. 523-526	
HD		U.S. Patent Application Serial No. 10/245,701 entitled Semiconductor Device and Method of Manufacturing the Same filed 09/18/2002	

Examiner Signature	Heather A. Doty	Date Considered	10/3/05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.